

DSF21060SV

FAST RECOVERY DIODE

APPLICATIONS

- Freewheel Diode.
- Antiparallel Diode.
- Inverters.
- Choppers.

KEY PARAMETERS

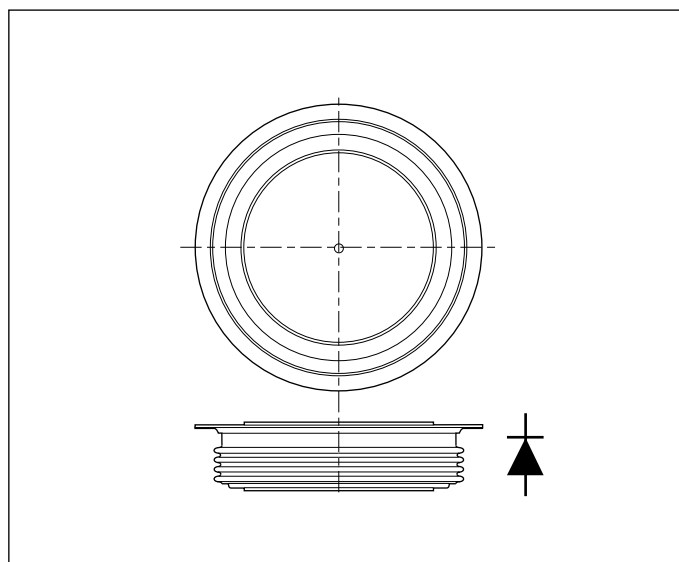
V_{RRM}	6000V
$I_{F(AV)}$	1690A
I_{FSM}	16000A
Q_r	1200 μ C
t_{rr}	6.5 μ s

FEATURES

- Double Side Cooling.
- High Surge Capability.
- Low Recovery Charge.

VOLTAGE RATINGS

Type Number	Repetitive Peak Reverse Voltage V_{RRM} V	Conditions
DSF21060SV60 DSF21060SV59 DSF21060SV58 DSF21060SV57 DSF21060SV56 DSF21060SV55	6000 5900 5800 5700 5600 5500	$V_{RSM} = V_{RRM} + 100V$



Outline type code: V. Turn to page 8 for further information.

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units
Double Side Cooled				
$I_{F(AV)}$	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	1690	A
$I_{F(RMS)}$	RMS value	$T_{case} = 65^{\circ}C$	2655	A
I_F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	2460	A
Single Side Cooled (Anode side)				
$I_{F(AV)}$	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	1090	A
$I_{F(RMS)}$	RMS value	$T_{case} = 65^{\circ}C$	1710	A
I_F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	1520	A

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I_{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 0% V_{RRM} , $T_j = 125^\circ\text{C}$	12.8	kA
I^2t	I^2t for fusing		819.2×10^3	A^2s
I_{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 50% V_{RRM} , $T_j = 125^\circ\text{C}$	16.0	kA
I^2t	I^2t for fusing		1280×10^3	A^2s
I_{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 100% V_{RRM} , $T_j = 125^\circ\text{C}$	-	kA
I^2t	I^2t for fusing		-	A^2s

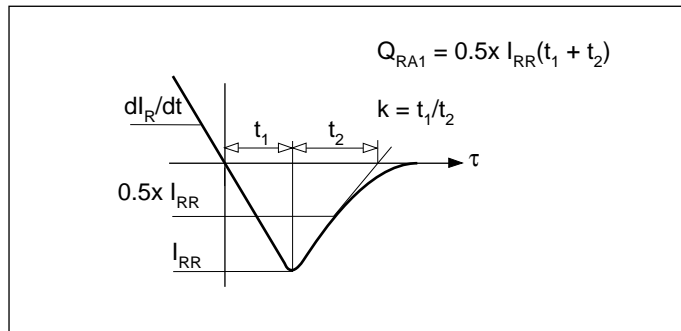
THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
$R_{th(j-c)}$	Thermal resistance - junction to case	Double side cooled	dc	-	0.0075	$^\circ\text{C/W}$
		Single side cooled	Anode dc	-	0.015	$^\circ\text{C/W}$
			Cathode dc	-	0.015	$^\circ\text{C/W}$
$R_{th(c-h)}$	Thermal resistance - case to heatsink	Clamping force 40.0kN with mounting compound	Double side	-	0.002	$^\circ\text{C/W}$
			Single side	-	0.004	$^\circ\text{C/W}$
T_{vj}	Virtual junction temperature	Forward (conducting)		-	130	$^\circ\text{C}$
T_{stg}	Storage temperature range			-55	150	$^\circ\text{C}$
-	Clamping force			36.0	44.0	kN

CHARACTERISTICS

Symbol	Parameter	Conditions	Typ.	Max.	Units
V_{FM}	Forward voltage	At 600A peak, $T_{case} = 25^{\circ}C$	-	3.0	V
I_{RRM}	Peak reverse current	At V_{RRM} , $T_{case} = 125^{\circ}C$	-	75	mA
t_{rr}	Reverse recovery time	$I_F = 1000A$, $di_{RR}/dt = 100A/\mu s$ $T_{case} = 125^{\circ}C$, $V_R = 100V$	-	6.5	μs
Q_{RA1}	Recovered charge (50% chord)		-	1500	μC
I_{RM}	Reverse recovery current		-	460	A
K	Soft factor		1.8	-	-
V_{TO}	Threshold voltage	At $T_{vj} = 125^{\circ}C$	-	1.625	V
r_T	Slope resistance	At $T_{vj} = 125^{\circ}C$	-	0.66	$m\Omega$
V_{FRM}	Forward recovery voltage	$di/dt = 1000A/\mu s$, $T_j = 100^{\circ}C$	140	-	V

DEFINITION OF K FACTOR AND Q_{RA1}



CURVES

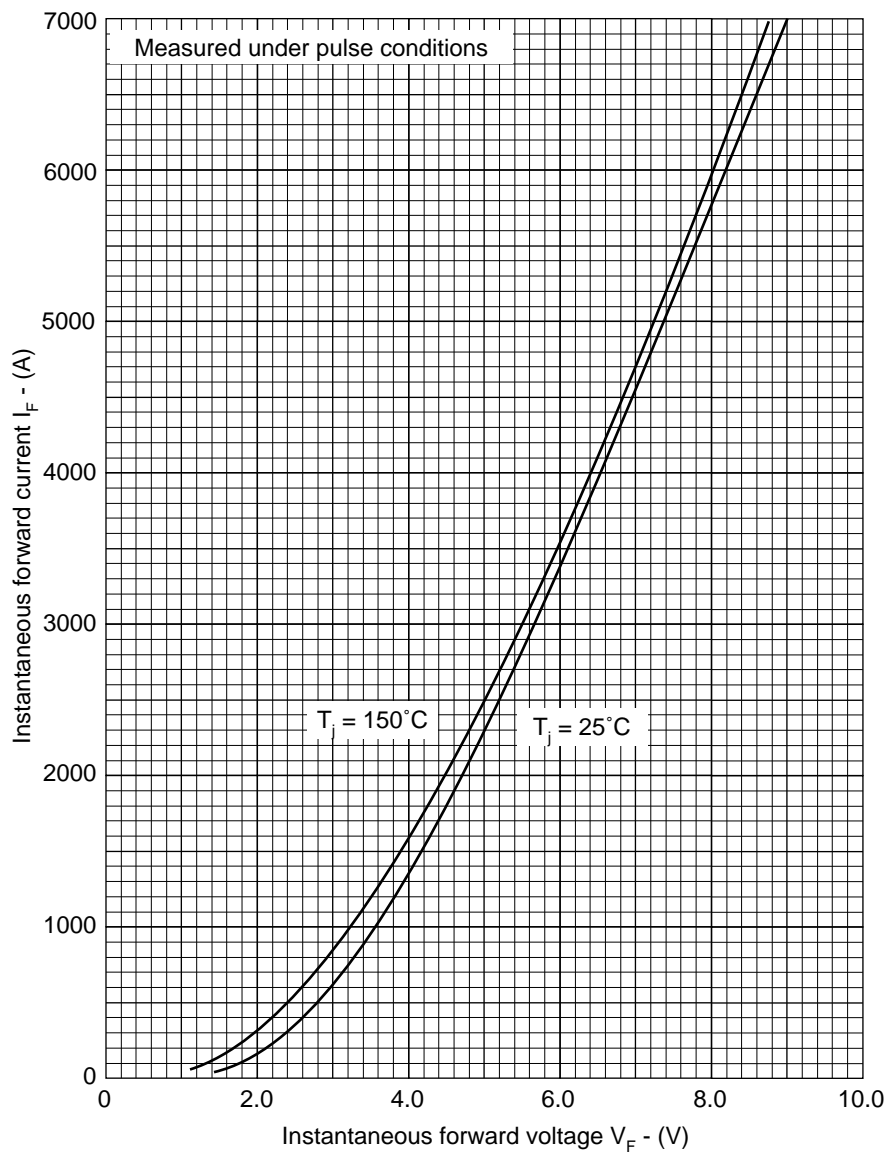


FIG. 1 MAXIMUM (LIMIT) FORWARD CHARACTERISTICS

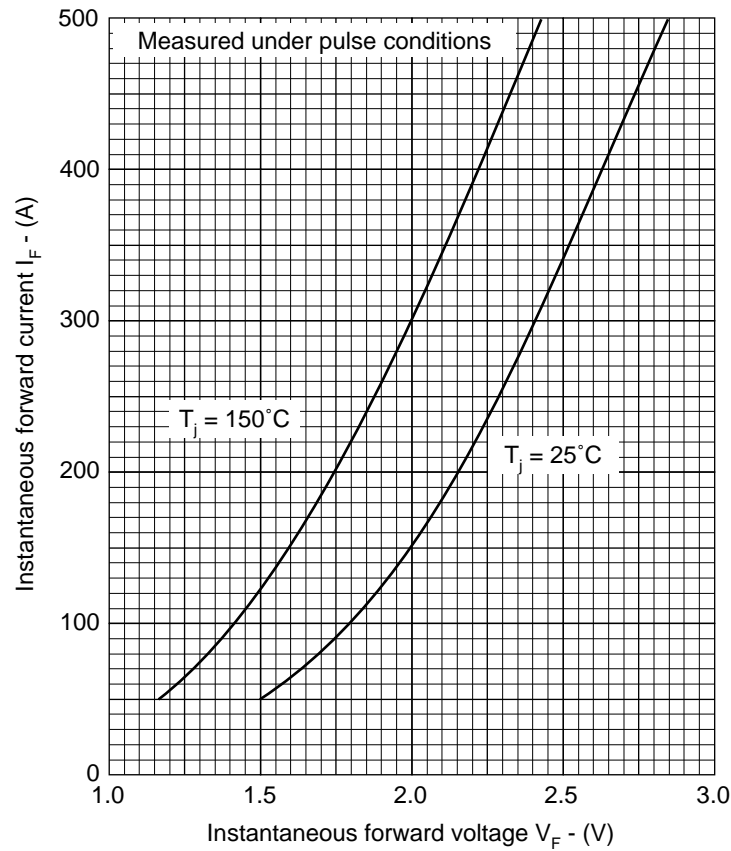


FIG. 2 MAXIMUM (LIMIT) FORWARD CHARACTERISTICS

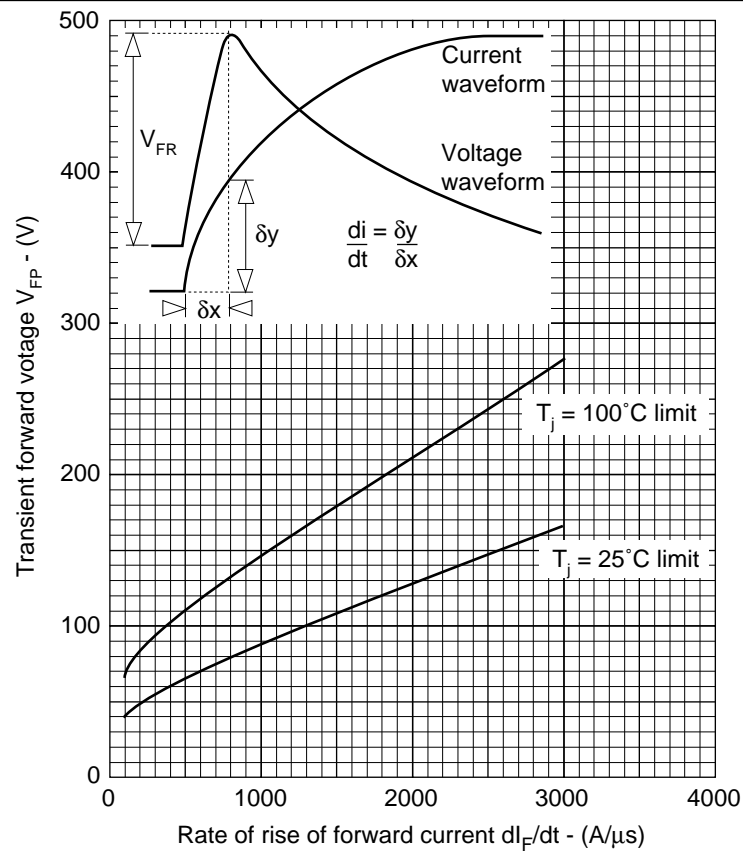


FIG. 3 TRANSIENT FORWARD VOLTAGE vs RATE OF RISE OF FORWARD CURRENT

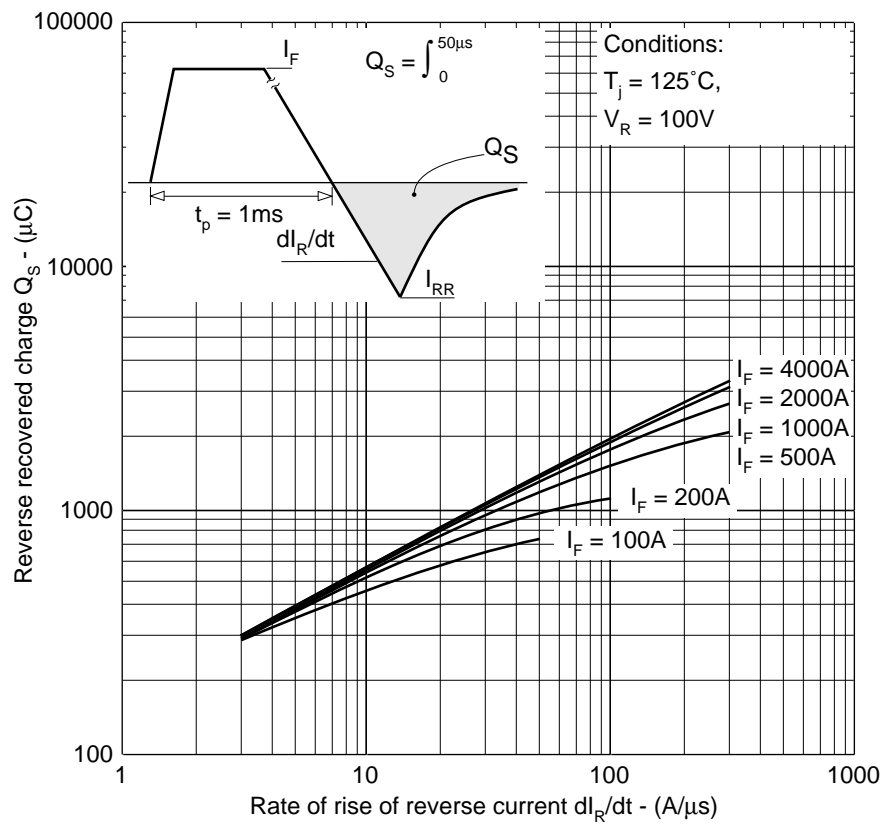


FIG. 4 RECOVERED CHARGE

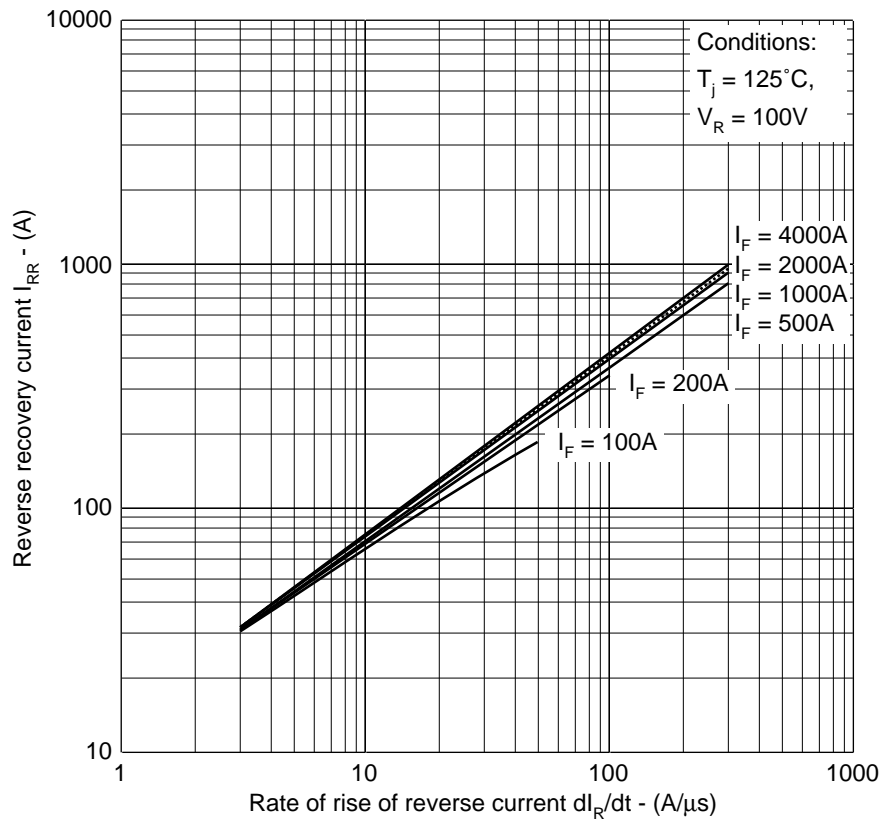


FIG. 5 TYPICAL REVERSE RECOVERY CURRENT vs RATE OF RISE OF REVERSE CURRENT

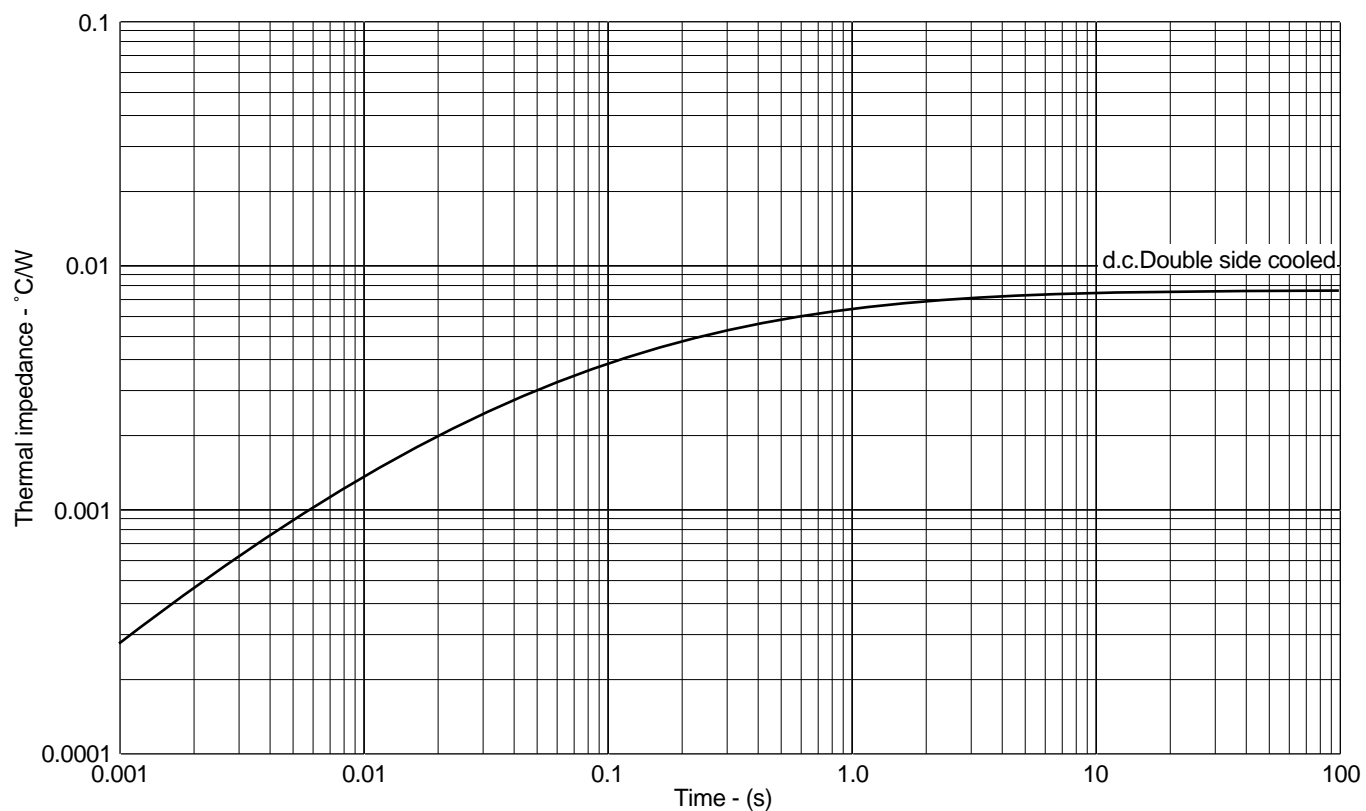
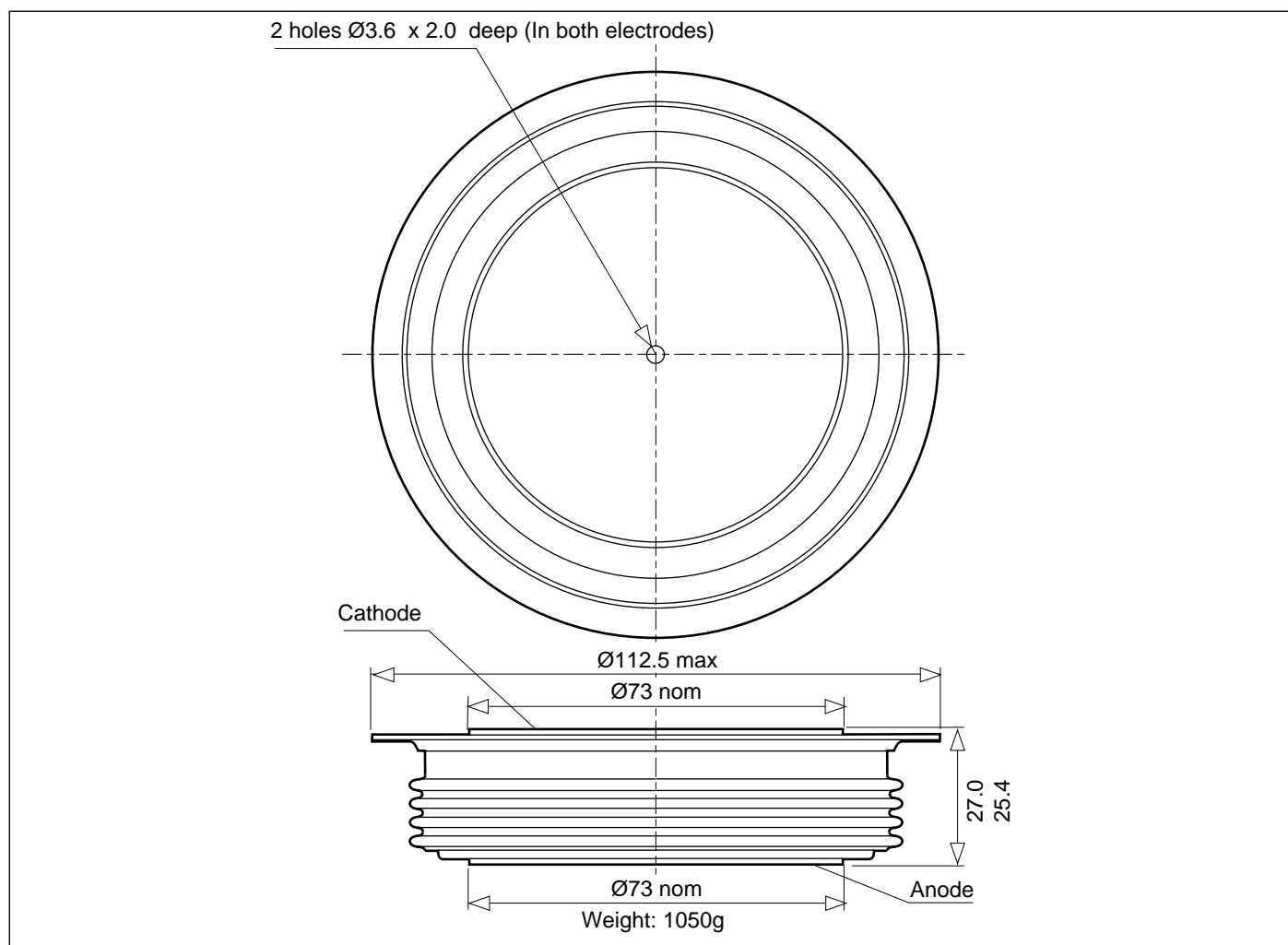


FIG. 5 MAXIMUM (LIMIT) TRANSIENT THERMAL IMPEDANCE - JUNCTION TO CASE

PACKAGE DETAILS - V

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise.
DO NOT SCALE.

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